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PD - 91747C

IRF7807/IRF7807A

HEXFET® Chip-Set for DC-DC Converters

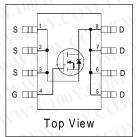
- N Channel Application Specific MOSFETs
- Ideal for Mobile DC-DC Converters
- Low Conduction Losses
- Low Switching Losses

Description

These new devices employ advanced HEXFET Power MOSFET technology to achieve an unprecedented balance of on-resistance and gate charge. The reduced conduction and switching losses make them ideal for high efficiency DC-DC Converters that power the latest generation of mobile microprocessors.

A pair of IRF7807 devices provides the best cost/ performance solution for system voltages, such as 3.3V





Device Features

IRF7807	IRF7807A
30V	30V
$25 \mathrm{m}\Omega$	$25 \text{m}\Omega$
17nC	17nC
5.2nC	-4
16.8nC	16.8nC
-31	
	30V 25mΩ 17nC 5.2nC

Absolute Maximum Ratings

Parameter	OM_{II}	Symbol	IRF7807	IRF7807A	Units
Drain-Source Voltage	MIIM	V _{DS}	1001.	30	V
Gate-Source Voltage	COTTY	V _{GS}	M. 1007.	±12	
Continuous Drain or Source	25°C	I _D	8.3	8.3	Α
Current (V _{GS} ≥ 4.5V)	70°C		6.6	6.6	
Pulsed Drain Current①	U.M.	I _{DM}	66	66	
Power Dissipation	25°C	P_{D}	P _D 2.5		W
	70°C		WWW	1.6	
Junction & Storage Temperatu	T_{J},T_{STG}	-55	N°C		
Continuous Source Current (B	ody Diode)①	Is	2.5	2.5	Α
Pulsed source Current	V 1007.	I _{SM}	66	66	

Thermal Resistance

Parameter	T.Co.	Max.	Units
Maximum Junction-to-Ambient®	$R_{\theta JA}$	50	°C/W
WMM'II	30 -		

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		10	IRF78	101	1 11	RF780		-	1100
Parameter	WW	Min	Тур	Max	Min	Тур	Max	Units	Conditions
Drain-to-Source Breakdown Voltage*	V _{(BR)DSS}	30	1002	.col	30	N -	_	V	$V_{GS} = 0V$, $I_D = 250\mu A$
Static Drain-Source on Resistance*	R _{DS} (on)		17	25	OM.	17	25	mΩ	$V_{GS} = 4.5V, I_{D} = 7A$ ②
Gate Threshold Voltage	V _{GS} (th)	1.0	N.10	07.	1.0	3.	т	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Drain-Source Leakage	I _{DSS}	MA	-xxi 1	30		1.11	30	μΑ	$V_{DS} = 24V, V_{GS} = 0$
Current*	N	W	NN	150	Y.CC	MT	150		$V_{DS} = 24V, V_{GS} = 0,$ Tj = 100°C
Gate-Source Leakage Current*	I _{GSS}			±100	ov.C	ON On	±100	nA	V _{GS} = ±12V
Total Gate Charge*	Q		12	17	00x.	12	17	-7	$V_{GS} = 5V, I_D = 7A$
Pre-Vth Gate-Source Charge	Q _{gs1}		2.1	WW	1007	2.1	M.T		$V_{DS} = 16V, I_{D} = 7A$
Post-Vth Gate-Source Charge	Q _{gs2}		0.76	NWY	21 10	0.76	0_{M}	nC	
Gate to Drain Charge	Q _{gd}	N	2.9	WW	-11	2.9		TI	
Switch Charge* $(Q_{gs2} + Q_{gd})$	Q _{sw}	W	3.66	5.2		3.66	CO	M.T	
Output Charge*	Q _{oss}	TA	14	16.8		14	16.8	OM:	$V_{DS} = 16V, V_{GS} = 0$
Gate Resistance	R _g	TTV	1.2	1		1.2	01.	Ω	TW
Turn-on Delay Time	t _d (on)	T	12		WW	12	OOY.		$V_{DD} = 16V$
Rise Time	t, CC	Nr.	17		W	17	.00	ns	$I_D = 7A$
Turn-off Delay Time	t _d (off)	O_{M}	25		< X	25	Too	V.CQ	$R_g = 2\Omega$
Fall Time	t _f	$CO_{\overline{M}}$	6	N	4	6	1.10	OY.C	V _{GS} = 4.5V Resistive Load

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Source-Drain Rating & Characteristics

Source-Drain Rating & Characteristics									
Parameter	W.In.	Min	Тур	Max	Min	Тур	Max	Units	Conditions
Diode Forward Voltage*	V _{SD}	OY.C	$O_{M'}$	1.2			1.2	V	$I_s = 7A@, V_{GS} = 0V$
Reverse Recovery Charge 4	Q _{rr}	001	80	M.TY	V CNI	80	NN	nC	di/dt = $700A/\mu s$ $V_{DS} = 16V, V_{GS} = 0V, I_{S} = 7A$
Reverse Recovery Charge (with Parallel Schotkky) @	Q _{rr(s)}	V 700	50	OM:	IN	50	W	NW.	di/dt = $700A/\mu s$ (with $10BQ040$) $V_{DS} = 16V$, $V_{GS} = 0V$, $I_{S} = 7A$

- Repetitive rating; pulse width limited by max. junction temperature.
- Pulse width $\leq 300 \, \mu s$; duty cycle $\leq 2\%$.
- When mounted on 1 inch square copper board, t < 10 sec.
- Typ = measured Q
- Devices are 100% tested to these parameters.

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Power MOSFET Selection for DC/DC Converters

Control FET

Special attention has been given to the power losses in the switching elements of the circuit - Q1 and Q2. Power losses in the high side switch Q1, also called the Control FET, are impacted by the $R_{\mbox{\tiny ds(on)}}$ of the MOSFET, but these conduction losses are only about one half of the total losses.

Power losses in the control switch Q1 are given by;

$$P_{loss} = P_{conduction} + P_{switching} + P_{drive} + P_{output}$$

This can be expanded and approximated by:

$$\begin{split} P_{loss} &= \left(I_{rms}^{2} \times R_{ds(on)}\right) \\ &+ \left(I \times \frac{Q_{gd}}{i_{g}} \times V_{in} \times f\right) + \left(I \times \frac{Q_{gs2}}{i_{g}} \times V_{in} \times f\right) \\ &+ \left(Q_{g} \times V_{g} \times f\right) \\ &+ \left(\frac{Q_{oss}}{2} \times V_{in} \times f\right) \end{split}$$

This simplified loss equation includes the terms $Q_{\rm gs2}$ and $Q_{\rm oss}$ which are new to Power MOSFET data sheets.

 Q_{gs2} is a sub element of traditional gate-source charge that is included in all MOSFET data sheets. The importance of splitting this gate-source charge into two sub elements, Q_{gs1} and Q_{gs2} , can be seen from Fig 1.

 Q_{gs2} indicates the charge that must be supplied by the gate driver between the time that the threshold voltage has been reached (t1) and the time the drain current rises to I_{dmax} (t2) at which time the drain voltage begins to change. Minimizing Q_{gs2} is a critical factor in reducing switching losses in Q1.

 $Q_{\rm oss}$ is the charge that must be supplied to the output capacitance of the MOSFET during every switching cycle. Figure 2 shows how $Q_{\rm oss}$ is formed by the parallel combination of the voltage dependant (non-linear) capacitance's $C_{\rm ds}$ and $C_{\rm dg}$ when multiplied by the power supply input buss voltage.

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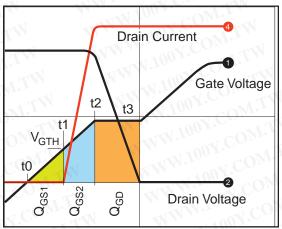


Figure 1: Typical MOSFET switching waveform

Synchronous FET

The power loss equation for Q2 is approximated by;

$$\begin{split} P_{loss} &= P_{conduction} + P_{drive} + P_{output}^* \\ P_{loss} &= \left(I_{rms}^2 \times R_{ds(on)}\right) \\ &+ \left(Q_g \times V_g \times f\right) \\ &+ \left(\frac{Q_{oss}}{2} \times V_{in} \times f\right) + \left(Q_{rr} \times V_{in} \times f\right) \end{split}$$

*dissipated primarily in Q1.

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For the synchronous MOSFET Q2, R $_{\rm ds(on)}$ is an important characteristic; however, once again the importance of gate charge must not be overlooked since it impacts three critical areas. Under light load the MOSFET must still be turned on and off by the control IC so the gate drive losses become much more significant. Secondly, the output charge $Q_{\rm oss}$ and reverse recovery charge $Q_{\rm rr}$ both generate losses that are transfered to Q1 and increase the dissipation in that device. Thirdly, gate charge will impact the MOSFETs' susceptibility to Cdv/dt turn on.

that device. Thirdly, gate charge will impact the MOSFETs' susceptibility to Cdv/dt turn on.

The drain of Q2 is connected to the switching node of the converter and therefore sees transitions between ground and V_{in}. As Q1 turns on and off there is a rate of change of drain voltage dV/dt which is capacitively coupled to the gate of Q2 and can induce

a voltage spike on the gate that is sufficient to turn

the MOSFET on, resulting in shoot-through current . The ratio of $Q_{\rm gd}/Q_{\rm gs1}$ must be minimized to reduce the potential for Cdv/dt turn on.

Spice model for IRF7807 can be downloaded in machine readable format at www.irf.com.

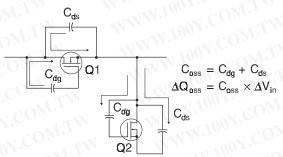
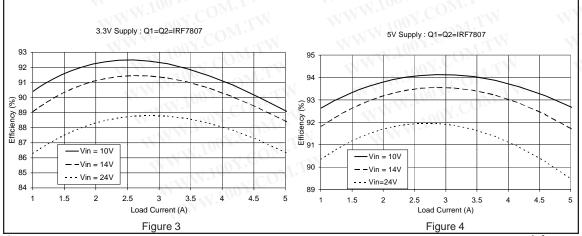


Figure 2: Qoss Characteristic

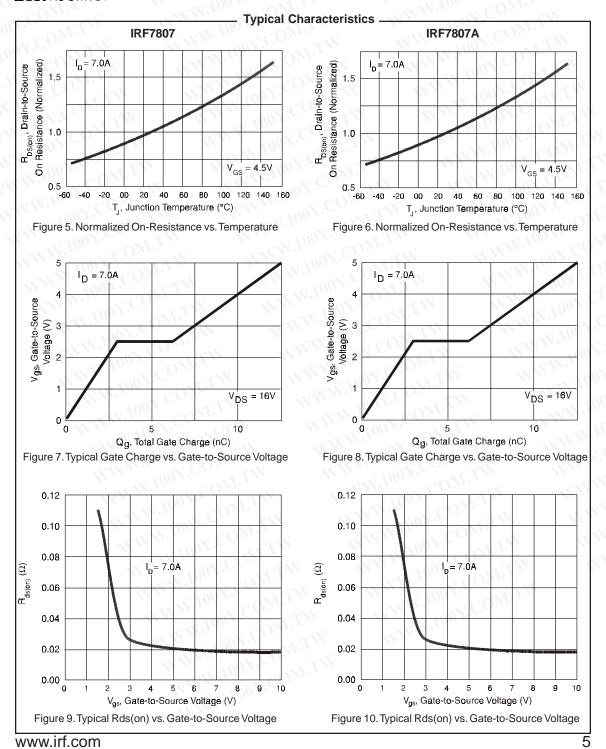
Typical Mobile PC Application

The performance of these new devices has been tested in circuit and correlates well with performance predictions generated by the system models. An advantage of this new technology platform is that the MOSFETs it produces are suitable for both control FET and synchronous FET applications. This has been demonstrated with the 3.3V and 5V converters. (Fig 3 and Fig 4). In these applications the same MOSFET IRF7807 was used for both the control FET (Q1) and the synchronous FET (Q2). This provides a highly effective cost/performance solution.



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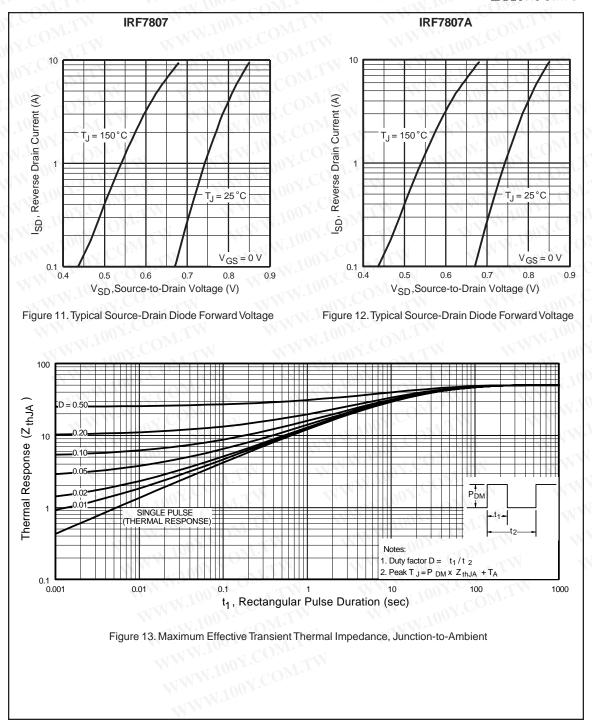
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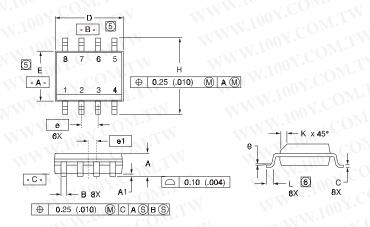


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Package Outline

SO-8 Outline

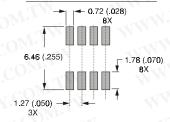


	INC	HES	MILLIMETERS				
DIM	MIN	MAX	MIN	MAX			
Α	.0532	.0688	1.35	1.75			
_A1	.0040	.0098	0.10	0.25			
В	.014	.018	0.36	0.46			
C	.0075	.0098	0.19	0.25			
D	.189	.196	4.80	4.98			
E	.150	.157	3.81	3.99			
е	.050 I	BASIC	1.27 BASIC				
e1	.025 I	BASIC	0.635 BASIC				
Н	.2284	.2440	5.80	6.20			
K	.011	.019	0.28	0.48			
L	.16	.050	0.41	1.27			
θ	0°	8°	0°	8°			

NOTES:

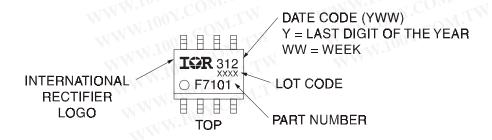
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.006).
- 6 DIMENSIONS IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE...

RECOMMENDED FOOTPRINT



Part Marking Information so-8

EXAMPLE: THIS IS AN IRF7101



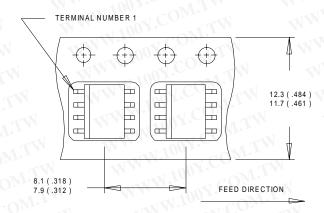
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Tape & Reel Information

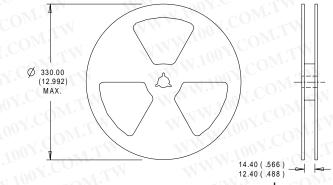
SO-8

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:
1. CONTROLLING DIMENSION: MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

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IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
IR EUROPEAN REGIONAL CENTRE: 439/445 Godstone Rd, Whyteleafe, Surrey CR3 OBL, UK Tel: ++ 44 (0)20 8645 8000
IR CANADA: 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200
IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 (0) 6172 96590
IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 011 451 0111
IR JAPAN: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo 171 Tel: 81 (0)3 3983 0086
IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 (0)838 4630
IR TAIWAN:16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673 Tel: 886-(0)2 2377 9936
Data and specifications subject to change without notice. 10/00